TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC259AP,TC74HC259AF

8-Bit Addressable Latch

The TC74HC259A is a high speed CMOS ADDRESSABLE LATCH fabricated with silicon gate C²MOS technology.

It achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The respective bits are controlled by address inputs A, B, and C. When \overline{CLEAR} input is held high and enable input G is held low, the data is written into the bit selected by address inputs, the other bit hold their previous conditions.

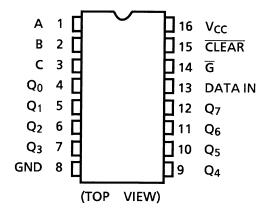
When both $\overline{\text{CLEAR}}$ and $\overline{\text{G}}$ held high, writing of all bits is inhibited regardless of adress inputs, and their previous condition are held. When $\overline{\text{CLEAR}}$ is held low and $\overline{\text{G}}$ is held high, all bits are resent to low regardless of the other inputs. When both of $\overline{\text{CLEAR}}$ and $\overline{\text{G}}$ held low, all bits which isn't selected by adress inputs are resent to low.

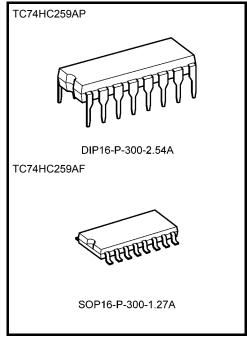
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $t_{pd} = 15 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2~6 V
- Pin and function compatible with 74LS259

Pin Assignment

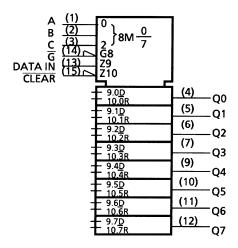




Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

IEC Logic Symbol



Truth Table

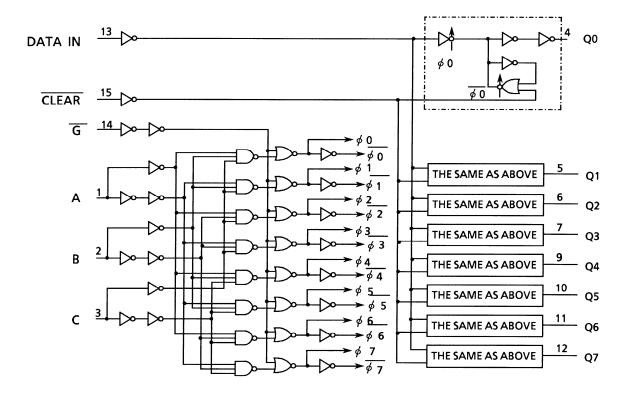
Inputs		Output of Addressed	Each Other	Function			
CLEAR	Ġ	Latch	Output	i direttori			
Н	L	D	QiO	Addressable Latch			
Н	Н	QiO	QiO	Memory			
L	L	D	L	8-Line Demultriplexer			
L	H L		L	Clear All Bits to "L"			

Se	lect Inp	uts	Latch Addressed			
С	В	Α	Laten Addressed			
L	L	L	Q0			
L	L	Н	Q1			
L	Н	L	Q2			
L	Н	Н	Q3			
Н	L	L	Q4			
Н	L	Н	Q5			
Н	Н	L	Q6			
Н	Н	Н	Q7			

D: The level at the data input.

QiO: The level before the indicared steady-state input conditions were established (i = 0, 1, 7)

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7.0	٧
DC input voltage	V _{IN}	-0.5~V _{CC} + 0.5	٧
DC output voltage	Vout	-0.5~V _{CC} + 0.5	٧
Input diode current	l _{IK}	±20	mA
Output diode current	I _{OK}	±20	mA
DC output current	I _{OUT}	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	P_{D}	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of $Ta = -40 \sim 65$ °C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied until 300 mW.

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Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2~6	V
Input voltage	V _{IN}	0~V _{CC}	V
Output voltage	V _{OUT}	0~V _{CC}	V
Operating temperature	T _{opr}	-40~85	°C
		0~1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0~500 (V _{CC} = 4.5 V)	ns
		0~400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

		Test Condition		Ta = 25°C			Ta = -4			
Characteristics	Symbol				Min	Тур.	Max	Min	Max	Unit
		_		2.0	1.50	_	_	1.50	_	
High-level input voltage	V _{IH}			4.5	3.15	_	_	3.15	_	V
· ·				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V _{IL}		_		_	_	1.35	_	1.35	V
· ·				6.0		_	1.80		1.80	
	Voн	V _{IN} = V _{IH} or V _{IL}		2.0	1.9	2.0	_	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			I _{OH} = -4 mA	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
		V _{IN} = V _{IH} or		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V _{OL}			6.0	_	0.0	0.1	_	0.1	V
, and the second		V _{IL}	I _{OL} = 4 mA	4.5		0.17	0.26	_	0.33	
			I _{OL} = 5.2 mA	6.0		0.18	0.26	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0		_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_C$	_C or GND	6.0	_	_	4.0	_	40.0	μА



Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 ~85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width			2.0	_	75	95	
(G)	t _{W (L)}	_	4.5	_	15	19	ns
(6)			6.0		13	16	
Minimum pulse width			2.0	_	75	95	
(CLEAR)	t _{W (L)}	_	4.5	_	15	19	ns
(OLLAIV)			6.0	_	13	16	
Minimum set-up time			2.0	_	50	60	
(DATA)	ts	_	4.5	_	10	12	ns
(DATA)			6.0	_	9	11	
Minimum set-up time			2.0	_	25	30	
(A, B, C)	ts	_	4.5	_	5	6	ns
(A, D, O)			6.0	_	5	5	
Minimum hold time			2.0	_	25	30	
(DATA)	t _h	_	4.5	_	5	6	ns
(DATA)			6.0	_	5	5	
Minimum hold time			2.0	_	0	0	
(A, B, C)	t _h	_	4.5	_	0	0	ns
(A, D, O)			6.0	_	0	0	

AC Characteristics (C $_L$ = 15 pF, V_{CC} = 5 V, Ta = 25 $^{\circ}\text{C},$ input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition		Тур.	Max	Unit
Output transition time	t _{TLH}	_		4	8	ns
Cuput transition time	t_{THL}	_				113
Propagation delay time	t _{pLH}			15	22	20
(DATA-Q)	t _{pHL}	_		15	22	ns
Propagation delay time	t _{pLH}			21	32	20
(A, B, C-Q)	t _{pHL}	_		21	32	ns
Propagation delay time	t _{pLH}			16	28	20
(G -Q)	t _{pHL}	_		10	20	ns
Propagation delay time				13	23	20
(CLEAR -Q)	t _{pHL}			13	23	ns



AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

		Test Condition		-	Га = 25°C)	Ta = -4		
Characteristics	Symbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
Output transition time	t _{TLH} t _{THL}	_	2.0 4.5 6.0	_ _ _	30 8 7	75 15 13	_ _ _	95 19 16	ns
Propagation delay time (DATA-Q)	t _{pLH}	_	2.0 4.5 6.0	_ _ _	56 18 15	130 26 22	_ _ _	165 33 28	ns
Propagation delay time (A, B, C-Q)	t _{pLH} t _{pHL}	_	2.0 4.5 6.0	_ _ _	83 25 21	185 37 31	_ _ _	230 46 39	ns
Propagation delay time	^t pLH ^t pHL	_	2.0 4.5 6.0	_ _ _	67 20 17	165 33 28	_ _ _	205 41 35	ns
Propagation delay time	^t pHL	_	2.0 4.5 6.0	_ _ _	52 16 14	135 27 23	_ _ _	170 34 29	ns
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Power dissipation capacitance	C _{PD} (Note)	_		_	35		_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

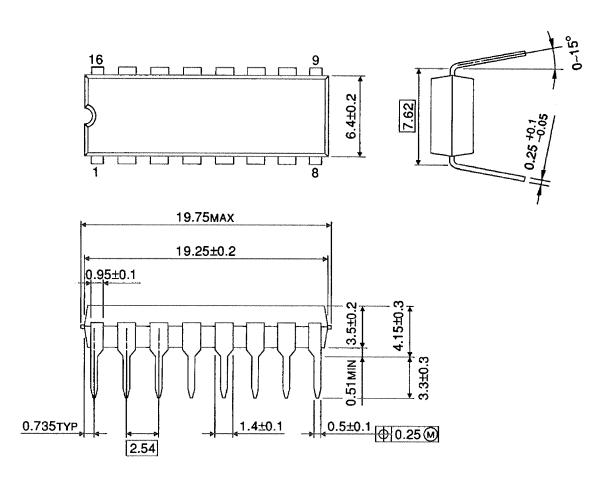
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Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

Package Dimensions

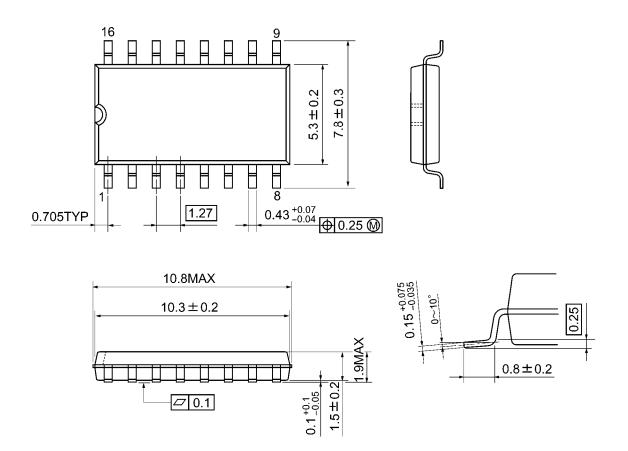
DIP16-P-300-2.54A Unit: mm



Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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